
Ultra Low Capacitance TVS Diode Array

Compliance Standard

- ◆ IEC 61000-4-2 (ESD)
30KV - Contact Discharge
30KV - Air Discharge
- ◆ IEC 61000-4-4 (EFT) 40A (5/50ns)
- ◆ IEC 61000-4-5 (Surge) 20.0 (8/20us)

Applications

- ◆ Ethernet Application
- ◆ HDMI Application
- ◆ Handheld Device
- ◆ Computer

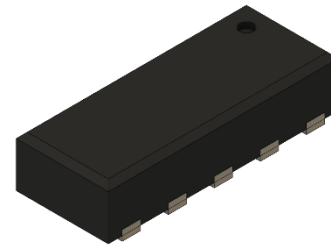
Features

- ◆ 300W Peak Pulse Power
- ◆ Low Clamping Voltage
- ◆ Low Leakage Current
- ◆ 4 Line Protection

Mechanical Characteristics

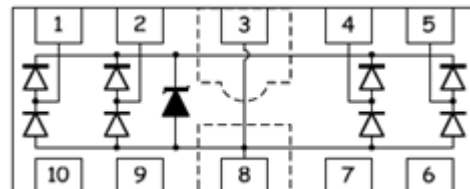
- ◆ DFN-2510P10 Package
- ◆ Weight 3 Milligram (Approximate)
- ◆ Flammability Rating UL94V-0
- ◆ Lead Free Plating
- ◆ Reel Size 7"
- ◆ 3000 PCS Per Reel

Package



DFN-2510P10

Pin Configuration



DEVICE CHARACTERISTICS

Maximum Rating			
Parameter	Symbol	Value	Unit
Peak Pulse Power	P _{PP}	300	Watt
Lead Soldering Temperature	T _L	260 (10s)	°C
Operating Temperature Range	T _J	-55~150	°C
Storage Temperature Range	T _{STG}	-55~150	°C

Electrical Characteristics (@25 °C)							
Part Number	Marking	V _{RWM} (Volt)	V _B (Volt)	V _C (Volt)	I _{PP} (A)	I _R (uA)	C _J (pF)
NLULC3324S	3A4U	3.3	3.6	15.0	20.0	1.0	1.0

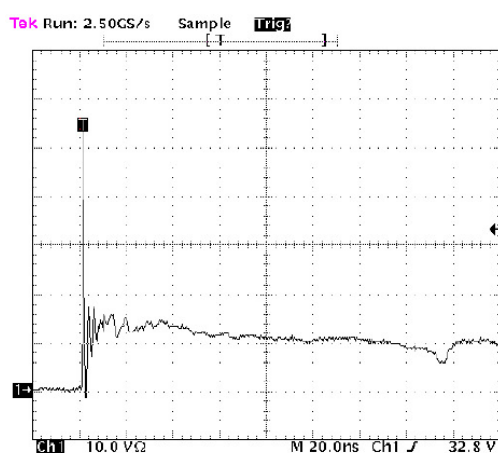


Figure1. Clamping waveform of positive 8KV ESD contact

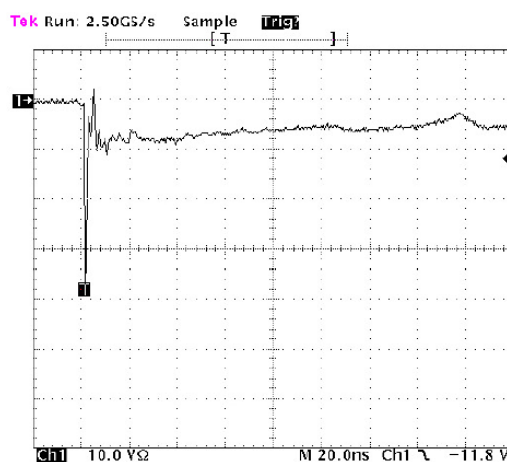
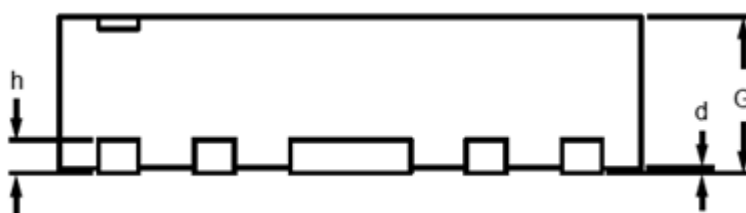
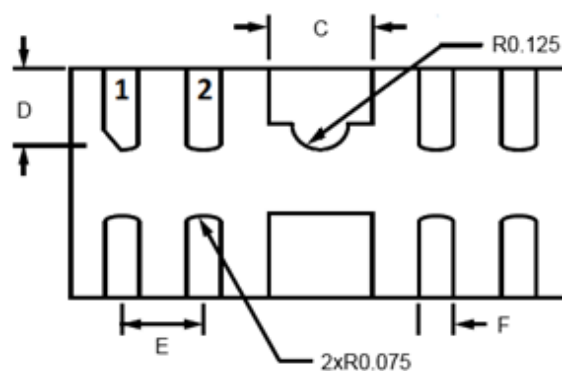
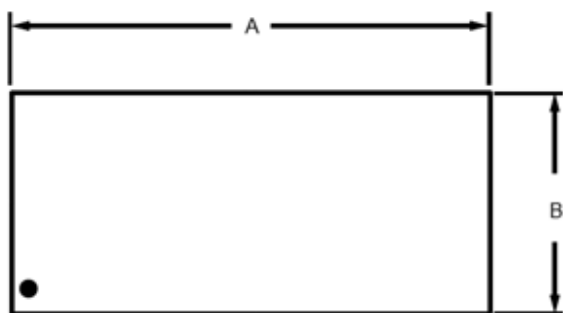


Figure2. Clamping waveform of negative 8KV ESD contact

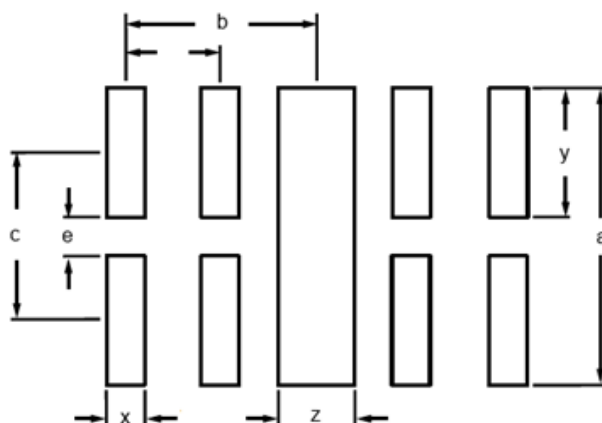
DEVICE OUTLINE

<i>Outline Dimension</i>				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	2.40	2.60	0.094	0.102
B	0.90	1.10	0.035	0.043
C	0.35	0.45	0.014	0.018
D	0.30	0.45	0.012	0.015
E	0.50TYP		0.50TYP	
F	0.15	0.25	0.006	0.010
G	0.50	0.65	0.020	0.026
d	0.00	0.05	0.000	0.002
h	0.15TYP		0.005TYP	



LAYOUT PAD DIMENSION

Layout PAD Dimension				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
a	1.55TYP		1.55TYP	
b	0.95	1.05	0.037	0.041
c	0.88TYP		0.88TYP	
e	0.15	0.25	0.006	0.010
x	0.20TYP		0.20TYP	
y	0.65	0.70	0.026	0.028
z	0.35	0.45	0.014	0.018



Revision History	Description
v2.0	Re-organize datasheet layout